

Modified Form PTO/SB/08A

Substitute for form 1449A/PTO  <b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>  (use as many sheets as necessary)		<i>Complete If Known</i>	
		Application Number	10/034,528
		First Named Inventor	Eldridge et al.
		Filing Date	December 27, 2001
		Group Art Unit	2829
		Examiner Name	Paresh H. Patel
No. of Sheets: 1	No. of Refs.: 6	Attorney Docket No.	P6C3-US

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		Office <sup>3</sup>	Number <sup>4</sup>	Kind Code <sup>5</sup>				
/P.P./	1	JP	03-65659		Takeda Sang Yo KK	20-Mar-91	Yes	X
/P.P./	2	JP	05-029406		Mitsubishi Electric Corp	5-Feb-93	Yes	X
/P.P./	3	JP	06-050990		NEC Corporation	25-Feb-94	Yes	X

OTHER PRIOR ART – NONPATENT LITERATURE DOCUMENTS				
Examiner Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published	Copy Enclosed	T <sup>2</sup>
/P.P./	4	"Development of Manufacturing Process for Membrane Probe Card," Research Institute: Korea Institute: Korea Institute of Machinery & Materials, pp. 1-62, (1992), Korea.	Yes	X
/P.P./	5	Korean Supreme Court, 1 <sup>st</sup> Division, Decision on Appeal, Case No. 2005 Heo 3284 Invalidation of Patent Registration, Phicom v. FormFactor, Inc.	Yes	X
/P.P./	6	Korean Patent Court, 3 <sup>rd</sup> Division, Decision re: Invalidation, Case No. 2004 Heo 8756 Invalidation of Patent Registration, Phicom v. FormFactor, Inc.	Yes	X

Examiner Signature	/Paresh Patel/	Date Considered	01/05/2008
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\* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication

<sup>1</sup>Unique citation designation number. <sup>2</sup>See attached Kinds of U.S. Patent Documents. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup>For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. <sup>6</sup>Applicant is to place a check mark here if English language Translation is attached.

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No. of Sheets: 9	No. of Refs.: 309	Attorney Docket No.	P6C3-US

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	245	EP	0 480 645 B1		Canon Kabushiki Kaisha	15-Apr-97	Yes	
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	247	EP	0 500 980 A1		Tencor Instruments	9-Feb-92	Yes	
/P.P./	248	EP	0 544 305 A2		Nitto Denko	2-Jun-93	Yes	

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	250	EP	0 665 590 B1		Canon Kabushiki Kaisha	2-Aug-95	Yes	
	251	EP	0 701 135 A1		Hughes Aircraft Company	13-Mar-96	Yes	
	252	EP	0 701 135 B1		Hughes Electronic Corporation	13-Mar-96	Yes	
	253	EP	0 707 310 A1		Hewlett-Packard Company	17-Apr-96	Yes	
	254	EP	0 711 029 B1		Canon Kabushiki Kaisha	8-May-96	Yes	
	255	EP	0 802 419 A2		NEC Corporation	22-Oct-97	Yes	
	256	EP	0 802 419 A3		NEC Corporation	12-Aug-98	Yes	
	257	FR	2639154		Christian et al.	18-May-90	Yes	
	258	JP	01-150862		Mitsubishi Electric Corp.	13-Jun-89	Yes	X
	259	JP	01-287484		Hitachi LTD	20-Nov-89	Yes	X
	260	JP	03-081669		Tokyo Kasoode Kenkyosho:KK	8-Apr-91	Yes	X
	261	JP	04-088649		Mitsubishi Electric Corp.	23-Mar-92	Yes	X
	262	JP	04-094147		Hitachi LTD	26-Mar-92	Yes	X
	263	JP	04-111331		Eito Kogyo:KK	13-Apr-92	Yes	X
	264	JP	04-360549		Nippon Denshi Zairo KK	14-Dec-92	Yes	X
	265	JP	04-361543		Mitsubishi Electric Corp	15-Dec-92	Yes	X
	266	JP	05-290907		Fujitsu Ltd.	5-Nov-93	Yes	X
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	268	JP	06-069294		Fuji Electric Co. Ltd.	11-Mar-94	Yes	X
	269	JP	06-151532		Tokyo Electron Yamanashi KK	31-May-94	Yes	X
	270	JP	06-204304		Oki Electric Ind Co Ltd	22-Jul-94	Yes	X
	271	JP	06-265577		Mitsubishi Electric Corp.	22-Sep-94	Yes	X
	272	JP	07-007052		Seiko-Epson Corp	10-Jan-95	Yes	X
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	276	JP	63-293934		Hitachi	30-Nov-88	Yes	X
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	282	WO	1990/015517		Labinal Components & Systems, Inc.	13-Dec-90	Yes	
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	293	BEILEY Mark et al., "A Micromachined Array Probe Card-Characterization," IEEE Transactions on Components, Packaging, and manufacturing Tehcnology - Part B, Vol. 18, No.1, pp.184-191, February 1995.	Yes		
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	305	STIX Gary, "Micron Machinations", published in Scientific American, pp.72-80, November 1992.	Yes	
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	308	"Phicom Corporation's Amended Invalidity And Unenforceability Contentions," FormFactor, Inc. v. Phicom Corporation, United States District Court District of Oregon (Case No. 05-6062-HO)	Yes	
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Examiner Signature	/Paresh Patel/	Date Considered	01/05/2008
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\* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication

<sup>1</sup>Unique citation designation number. <sup>2</sup>See attached Kinds of U.S. Patent Documents. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup>For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. <sup>6</sup>Applicant is to place a check mark here if English language Translation is attached.

# Commonly owned US patent or application whose subject matter may be related to the subject matter of the instance patent application.

Modified Form PTO/SB/08A

Substitute for form 1449A/PTO  <b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>  (use as many sheets as necessary)		<i>Complete If Known</i>	
		Application Number	10/034,528
		First Named Inventor	Eldridge et al.
		Filing Date	December 27, 2001
		Group Art Unit	2829
		Examiner Name	Paresh H. Patel
No. of Sheets: 9	No. of Refs.: 364	Attorney Docket No.	P6C3-US

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